

November 1994

# 54F/74F139 **Dual 1-of-4 Decoder/Demultiplexer**

### **General Description**

The 'F139 is a high-speed, dual 1-of-4 decoder/demultiplexer. The device has two independent decoders, each accepting two inputs and providing four mutually exclusive active LOW outputs. Each decoder has an active LOW Enable input which can be used as a data input for a 4-output demultiplexer. Each half of the 'F139 can be used as a function generator providing all four minterms of two variables.

#### **Features**

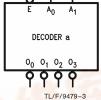
- Multifunction capability
- Two completely independent 1-of-4 decoders
- Active LOW mutually exclusive outputs
- Guaranteed 4000V minimum ESD protection

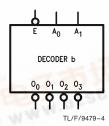
| Commercial        | Military          | Package<br>Number | Package Description                               |  |  |
|-------------------|-------------------|-------------------|---|--|--|
| 74F139PC          |                   | N16E              | 16-Lead (0.300" Wide) Molded Dual-In-Line         |  |  |
|                   | 54F139DM (Note 2) | J16A              | 16- <mark>Lead Cerami</mark> c Dual-In-Line       |  |  |
| 74F139SC (Note 1) |                   | M16A              | 16-Lead (0.150" Wide) Molded Small Outline, JEDEC |  |  |
| 74F139SJ (Note 1) | en-TIVE           | M16D              | 16-Lead (0.300" Wide) Molded Small Outline, EIAJ  |  |  |
| - sty Corn        | 54F139FM (Note 2) | W16A              | 16-Lead Cerpack                                   |  |  |
|                   | 54F139LM (Note 2) | E20A              | 20-Lead Ceramic Leadless Chip Carrier, Type C     |  |  |

Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

# **Logic Symbols**





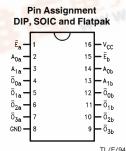


ō<sub>0a</sub>  $\bar{o}_{ob}$  $A_{Ob}$ A<sub>1b</sub>  $\bar{o}_{2b}$  $\bar{o}_{3b}$ 

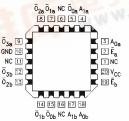
IEEE/IEC

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## **Connection Diagrams**







TL/F/9479-2

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TL/F/9479-7

RRD-B30M75/Printed in U. S. A.



# **Unit Loading/Fan Out**

|  |  | 54F/74F                       |   |  |  |
|--|--|-------------------------------|---|--|--|
| Pin Names  | Description  | U.L.<br>HIGH/LOW              | Input I <sub>IH</sub> /I <sub>IL</sub><br>Output I <sub>OH</sub> /I <sub>OL</sub> |  |  |
| $ \begin{array}{c} A_0, A_1 \\ \overline{E} \\ \overline{O}_0 - \overline{O}_3 \end{array} $ | Address Inputs Enable Inputs (Active LOW) Outputs (Active LOW) | 1.0/1.0<br>1.0/1.0<br>50/33.3 | 20 μA/ - 0.6 mA<br>20 μA/ - 0.6 mA<br>- 1 mA/20 mA                                |  |  |

### **Functional Description**

The 'F139 is a high-speed dual 1-of-4 decoder/demultiplexer. The device has two independent decoders, each of which accepts two binary weighted inputs  $(A_0-A_1)$  and provides four mutually exclusive active LOW Outputs  $(\overline{O}_0-\overline{O}_3)$ . Each decoder has an active LOW enable  $(\overline{E})$ . When  $\overline{E}$  is HIGH all outputs are forced HIGH. The enable can be used

as the data input for a 4-output demultiplexer application. Each half of the 'F139 generates all four minterms of two variables. These four minterms are useful in some applications, replacing multiple gate functions as shown in *Figure 1*, and thereby reducing the number of packages required in a logic network.

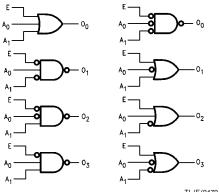
#### **Truth Table**

|   | Inputs         |                | Outputs          |                  |                  |                  |  |  |
|---|----------------|----------------|------------------|------------------|------------------|------------------|--|--|
| Ē | A <sub>0</sub> | A <sub>1</sub> | $\overline{O}_0$ | $\overline{O}_1$ | $\overline{O}_2$ | $\overline{O}_3$ |  |  |
| Н | Х              | Х              | Н                | Н                | Н                | Н                |  |  |
| L | L              | L              | L                | Н                | Н                | Н                |  |  |
| L | Н              | L              | Н                | L                | Н                | Н                |  |  |
| L | L              | Н              | Н                | Н                | L                | Н                |  |  |
| L | Н              | Н              | Н                | Н                | Н                | L                |  |  |

H = HIGH Voltage Level

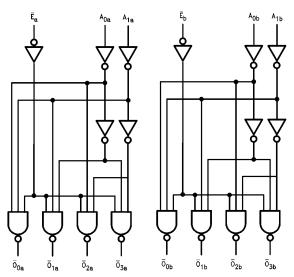
L = LOW Voltage Level

X = Immaterial



TL/F/9479-6 FIGURE 1. Gate Functions (each half)

## **Logic Diagram**



TL/F/9479-5

Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

#### **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 $\begin{array}{lll} \text{Storage Temperature} & -65^{\circ}\text{C to} + 150^{\circ}\text{C} \\ \text{Ambient Temperature under Bias} & -55^{\circ}\text{C to} + 125^{\circ}\text{C} \\ \text{Junction Temperature under Bias} & -55^{\circ}\text{C to} + 175^{\circ}\text{C} \\ \text{Plastic} & -55^{\circ}\text{C to} + 150^{\circ}\text{C} \\ \end{array}$ 

V<sub>CC</sub> Pin Potential to

 Ground Pin
 − 0.5V to +7.0V

 Input Voltage (Note 2)
 − 0.5V to +7.0V

 Input Current (Note 2)
 −30 mA to +5.0 mA

Voltage Applied to Output

in HIGH State (with  $V_{CC} = 0V$ )

 $\begin{array}{lll} \text{Standard Output} & -0.5 \text{V to V}_{\text{CC}} \\ \text{TRI-STATE} \tiny{\$} \text{ Output} & -0.5 \text{V to } +5.5 \text{V} \end{array}$ 

Current Applied to Output

in LOW State (Max) twice the rated  $I_{OL}$  (mA) ESD Last Passing Voltage (Min) 4000V

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

# Recommended Operating Conditions

Free Air Ambient Temperature

Supply Voltage Military

Military +4.5V to +5.5V Commercial +4.5V to +5.5V

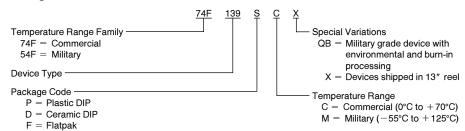
## **DC Electrical Characteristics**

| Symbol           | Parameter  |  | 54F/74F           |     |             | Units  | v <sub>cc</sub> | Conditions   |  |
|------------------|--|--|-------------------|-----|-------------|--------|-----------------|--|--|
| Symbol           |  |  | Min               | Тур | Max         | Oilles | •60             | Conditions   |  |
| V <sub>IH</sub>  | Input HIGH Voltage   |  | 2.0               |     |             | V      |                 | Recognized as a HIGH Signal  |  |
| V <sub>IL</sub>  | Input LOW Voltage  |  |                   |     | 0.8         | V      |                 | Recognized as a LOW Signal   |  |
| V <sub>CD</sub>  | Input Clamp Diode Vo   | oltage   |                   |     | -1.2        | V      | Min             | $I_{\text{IN}} = -18 \text{ mA}$   |  |
| V <sub>OH</sub>  | Output HIGH 54F 10% V <sub>CC</sub> Voltage 74F 10% V <sub>CC</sub> 74F 5% V <sub>CC</sub> |  | 2.5<br>2.5<br>2.7 |     |             | V      | Min             | $I_{OH} = -1 \text{ mA}$<br>$I_{OH} = -1 \text{ mA}$<br>$I_{OH} = -1 \text{ mA}$ |  |
| V <sub>OL</sub>  | Output LOW<br>Voltage  | 54F 10% V <sub>CC</sub><br>74F 10% V <sub>CC</sub> |                   |     | 0.5<br>0.5  | V      | Min             | $I_{OL} = 20 \text{ mA}$<br>$I_{OL} = 20 \text{ mA}$                             |  |
| I <sub>IH</sub>  | Input HIGH<br>Current  | 54F<br>74F   |                   |     | 20.0<br>5.0 | μΑ     | Max             | V <sub>IN</sub> = 2.7V   |  |
| I <sub>BVI</sub> | Input HIGH Current<br>Breakdown Test   | 54F<br>74F   |                   |     | 100<br>7.0  | μΑ     | Max             | V <sub>IN</sub> = 7.0V   |  |
| I <sub>CEX</sub> | Output HIGH<br>Leakage Current   | 54F<br>74F   |                   |     | 250<br>50   | μΑ     | Max             | $V_{OUT} = V_{CC}$   |  |
| V <sub>ID</sub>  | Input Leakage<br>Test  | 74F  | 4.75              |     |             | V      | 0.0             | $I_{\text{ID}} = 1.9  \mu\text{A}$ All Other Pins Grounded                       |  |
| I <sub>OD</sub>  | Output Leakage<br>Circuit Current  | 74F  |                   |     | 3.75        | μΑ     | 0.0             | V <sub>IOD</sub> = 150 mV<br>All Other Pins Grounded                             |  |
| I <sub>IL</sub>  | Input LOW Current  |  |                   |     | -0.6        | mA     | Max             | $V_{IN} = 0.5V$  |  |
| los              | Output Short-Circuit Current   |  | -60               |     | -150        | mA     | Max             | $V_{OUT} = 0V$   |  |
| _lcc             | Power Supply Current   |  |                   | 13  | 20          | mA     | Max             |  |  |

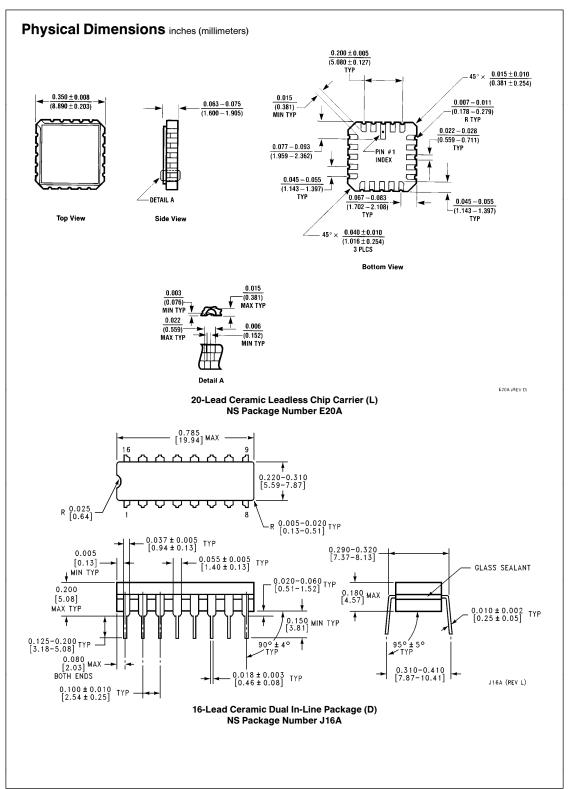
## **AC Electrical Characteristics**

|                  | Parameter  | $74F$ $T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$ |            |            | 54F   |             | 74F  |            | Units |
|------------------|--|---|------------|------------|---|-------------|--|------------|-------|
| Symbol           |  |   |            |            | $	extsf{T}_{	extsf{A}}, 	extsf{V}_{	extsf{CC}} = 	extsf{Mil} \ 	extsf{C}_{	extsf{L}} = 	extsf{50 pF}$ |             | T <sub>A</sub> , V <sub>CC</sub> = Com<br>C <sub>L</sub> = 50 pF |            |       |
|                  |  | Min   | Тур        | Max        | Min   | Max         | Min  | Max        |       |
| t <sub>PLH</sub> | Propagation Delay $A_0$ or $A_1$ to $\overline{O}_n$   | 3.5<br>4.0  | 5.3<br>6.1 | 7.5<br>8.0 | 2.5<br>3.5  | 12.0<br>9.5 | 3.0<br>4.0   | 8.5<br>9.0 | ns    |
| t <sub>PLH</sub> | Propagation Delay $\overline{E}_1$ to $\overline{O}_n$ | 3.5<br>3.0  | 5.4<br>4.7 | 7.0<br>6.5 | 3.0<br>2.5  | 9.0<br>8.0  | 3.5<br>3.0   | 8.0<br>7.5 | ns    |

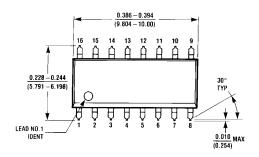
# **Ordering Information**

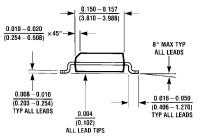


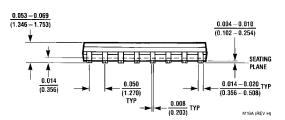
L = Leadless Chip Carrier (LCC)
S = Small Outline SOIC JEDEC
SJ = Small Outline SOIC EIAJ



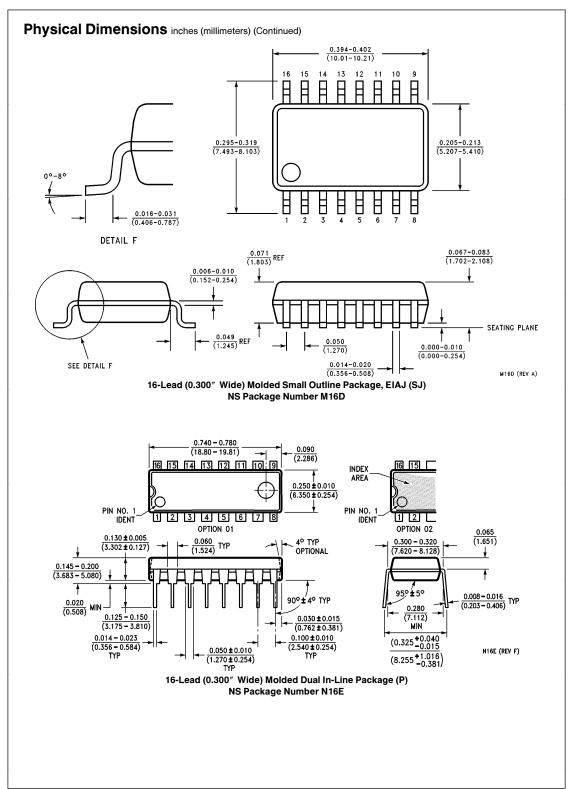
# Physical Dimensions inches (millimeters) (Continued)



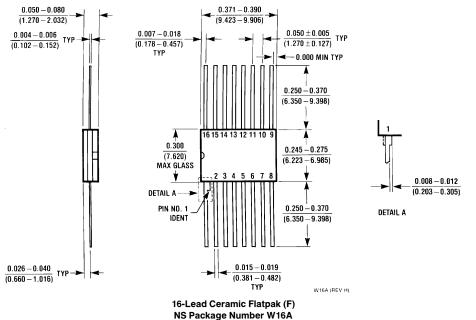




16-Lead (0.150" Wide) Molded Small Outline Integrated Circuit (S) NS Package Number M16A



# Physical Dimensions inches (millimeters) (Continued)



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